

Silicon Carbide Power MOSFET

C3M[™] MOSFET Technology

N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant

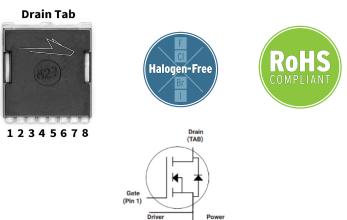
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

- Datacenter Power Supplies
- Telecom Power Supplies
- Energy Storage Systems
- Solar (PV) inverters
- High Voltage DC/DC converters

Package



Orderable Part Number	Package	Marking
C3M0045065L-TR	TOLL	C3M0045065L

(Pin 3,4,5,6,7,8)

Source (Pin 2)

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			650		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
				49		$V_{_{GS}} = 15 \text{ V}, \text{ T}_{_{C}} = 25 \text{ °C}, \text{ T}_{_{J}} \le 175 \text{ °C}$	Fig. 19
DC Continuous Drain Current	I _D			33	А	V _{GS} = 15 V, T _C = 100 °C, T _J ≤175 °C	Note 2
Pulsed Drain Current	I _{DM}			132		t _{Pmax} limited by T _{jmax} V _{GS} = 15V, T _c = 25 °C	Fig. 22
Power Dissipation	P _D			164	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Junction Temperature	T,			-40 to +175			
Case and Storage Temperature	T _c , T _{stg}			-40 to +150	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	650		1	V	V_{GS} = 0 V, I _D = 100 µA	
V Out T		1.8	2.6	3.6	V	V _{DS} = V _{GS} , I _D = 4.84 mA	- Fig. 11
$V_{\text{GS(th)}}$	Gate Threshold Voltage		2.2		V	V _{DS} = V _{GS} , I _D = 4.84 mA, T _J = 175°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V_{GS} = 15 V, V_{DS} = 0 V	
Þ	Drain-Source On-State Resistance		45	60	mΩ	V _{GS} = 15 V, I _D = 17.6 A	Fig. 4, 5, 6
$R_{\text{DS(on)}}$			61			V _{GS} = 15 V, I _D = 17.6 A, T _J = 175°C	
G .	Transconductance		12		s	V _{DS} = 20 V, I _{DS} = 17.6 A	Fig. 7
g _{fs}	Transconductance		11			V _{DS} = 20 V, I _{DS} = 17.6 A, T _J = 175°C	Fig. 7
C _{iss}	Input Capacitance		1621			y = 0 y y = 400 y	
C _{oss}	Output Capacitance		101		PF V _{GS} = 0 V, V _{DS} = 400 V F = 1 Mhz		Fig. 17, 18
C _{rss}	Reverse Transfer Capacitance		8		1	$V_{AC} = 25 \text{ mV}$	
E _{oss}	Coss Stored Energy		20		μJ	V _{DS} = 600 V, F = 1 Mhz	
$C_{o\left(er\right) }$	Effective Output Capacitance (Energy Related)		126		pF		Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		178		pF	V _{GS} = 0 V, V _{DS} = 0 400V	
Eon	Turn-On Switching Energy (Body Diode FWD)		53		V _{DS} = 400 V, V _{GS} = -4 V/15 V, I _D = 17.6A		
Eoff	Turn-Off Switching Energy (Body Diode FWD)		10		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 99 µH, T _J = 25°C FWD = Internal Body Diode	Fig. 23
t _{d(on)}	Turn-On Delay Time		7				5.0.00
tr	Rise Time		9			V_{DD} = 400 V, V_{GS} = -4 V/15 V I _D = 17.6 A, $R_{G(ext)}$ = 2.5 Ω,	
$t_{\text{d(off)}}$	Turn-Off Delay Time		17		Timing relative to V _{DS}		Fig. 26
t _f	Fall Time		6		1		
R _{G(int)}	Internal Gate Resistance		3		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		20			V _{DS} = 400 V, V _{GS} = -4 V/15 V	
Q_{gd}	Gate to Drain Charge	İ	16]	nC	I _D = 17.6 A	Fig. 12
Qg	Total Gate Charge	l i	59	Per IEC60747-8-4 pg 21		Per IEC60747-8-4 pg 21	

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): C_{o(er)}, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V



Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
	Diada Famuand Valtana	4.8		V	V _{GS} = -4 V, I _{SD} = 8.8 A, T _J = 25 °C	Fig. 8,
V _{SD}	Diode Forward Voltage	4.2		V	V _{gs} = -4 V, I _{sd} = 8.8 A, T _J = 175 °C	9,10
ls	Continuous Diode Forward Current		28	А	V _{GS} = -4 V, T _C = 25°C	
I _{S, pulse}	Diode pulse Current		132	А	$V_{_{GS}}$ = -4 V, pulse width $t_{\rm p}$ limited by $T_{_{jmax}}$	
t _{rr}	Reverse Recover time	10		ns		
Q _{rr}	Reverse Recovery Charge	207		nC	V _{GS} = -4 V, I _{SD} = 17.6 A, V _R = 400 V dif/dt = 6580 A/μs, Τ _J = 25 °C	
I _{rrm}	Peak Reverse Recovery Current	38		A		
t _{rr}	Reverse Recover time	12		ns		
Q _{rr}	Reverse Recovery Charge	94		nC	V _{GS} = -4 V, I _{SD} = 17.6 A, V _R = 400 V dif/dt = 2260 A/µs, T _J = 25 °C	
I _{rrm}	Peak Reverse Recovery Current	14		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
R _{θJC}	$R_{\scriptscriptstyle \theta JC}$ Thermal Resistance from Junction to Case		°C/W		Fig. 21



Typical Performance

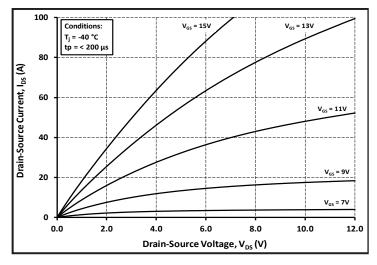
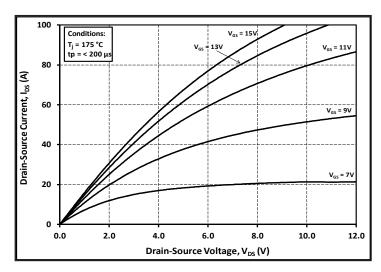
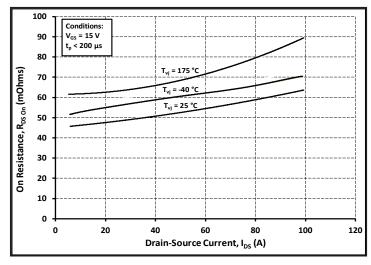
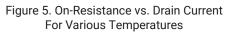


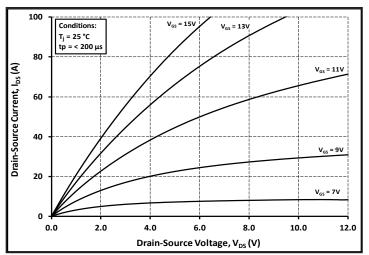
Figure 1. Output Characteristics T_J = -40 °C



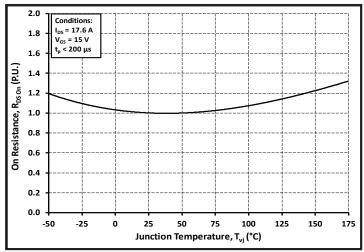




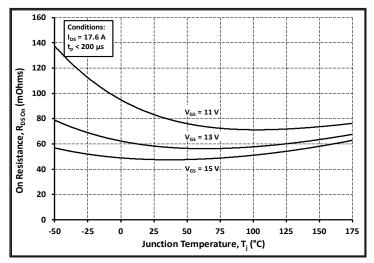












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Figure 6. On-Resistance vs. Temperature
For Various Gate Voltage
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Typical Performance

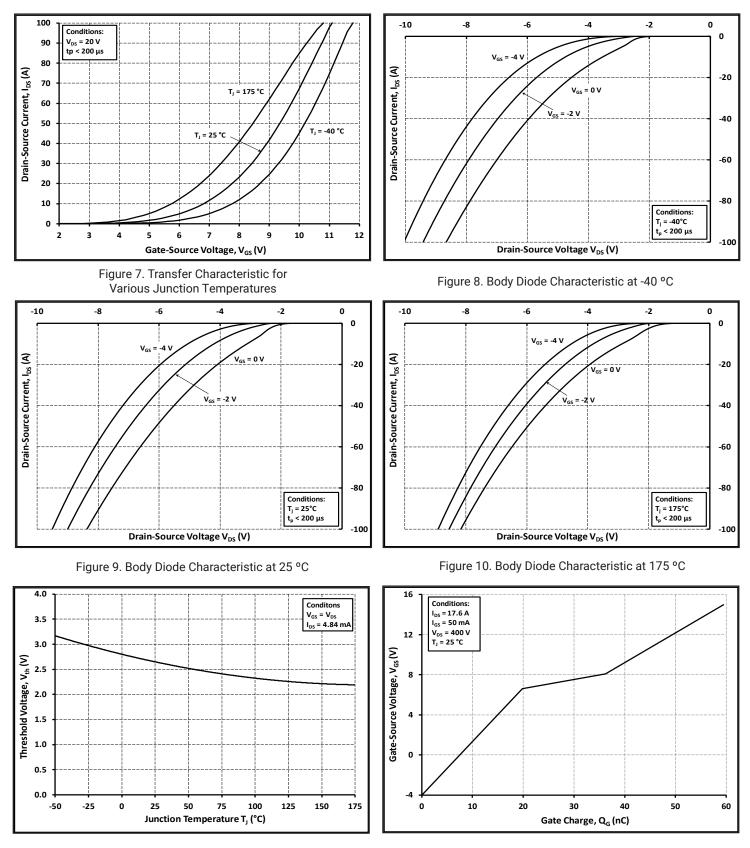


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics

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Typical Performance

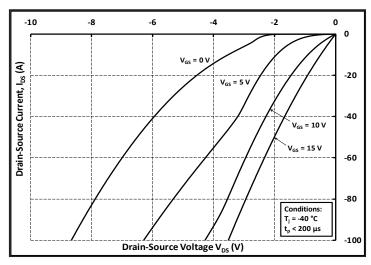


Figure 13. 3rd Quadrant Characteristic at -40 °C

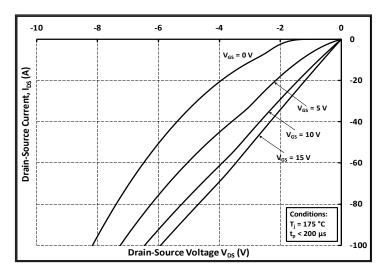
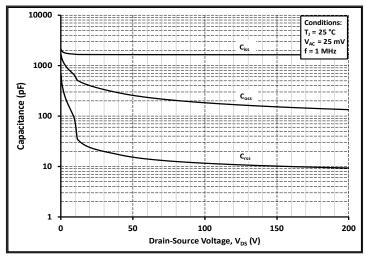
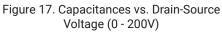


Figure 15. 3rd Quadrant Characteristic at 175 °C





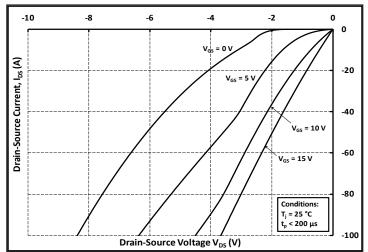


Figure 14. 3rd Quadrant Characteristic at 25 °C

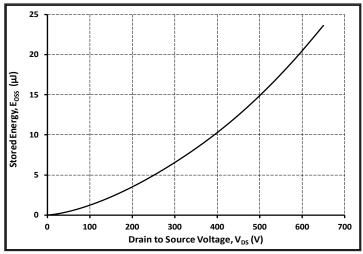


Figure 16. Output Capacitor Stored Energy

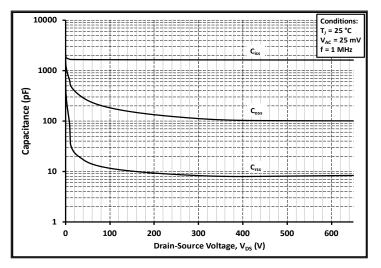
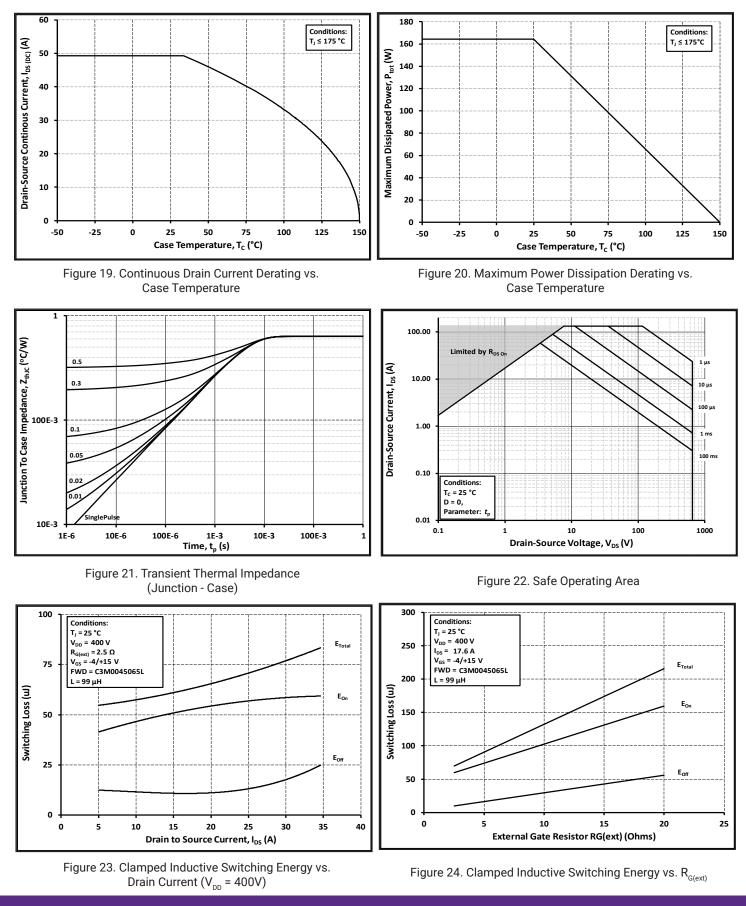


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)

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Typical Performance



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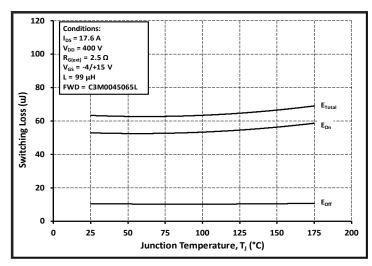


Figure 25. Clamped Inductive Switching Energy vs. Temperature

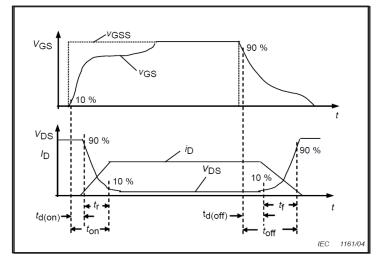


Figure 27. Switching Times Definition

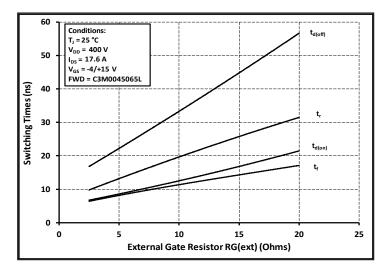


Figure 26. Switching Times vs. $R_{G(ext)}$

Test Circuit Schematic



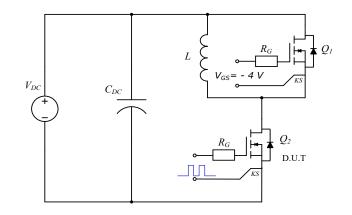


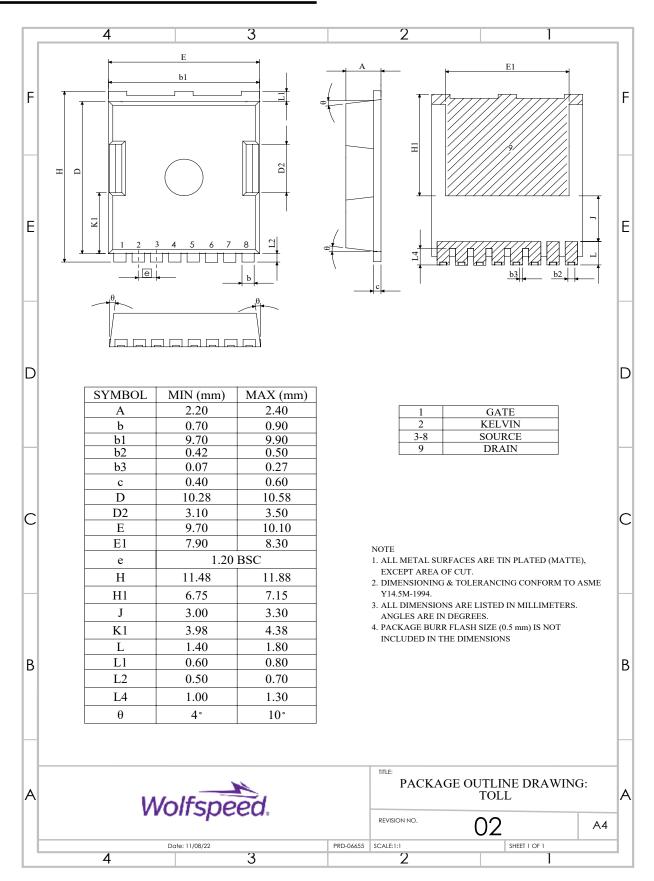
Figure 28. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions



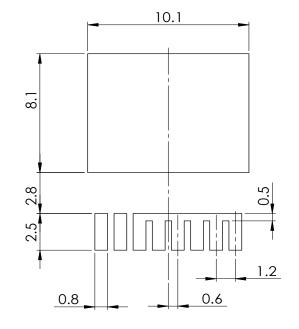


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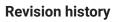
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Recommended Solder Pad Layout

(Note: All Dimensions are listed in Millimeters)



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Document Version	Date of release	Description of changes
1.0	September-2022	Initial datasheet
2.0	November-2022	Correction in the placement of "E1" package dimension Orderable part number information added
3	December - 2024	Legal disclaimer, Table 1 layout revised



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